Onsemi

Current Sense Amplifier, 80 V Common-Mode Voltage, Unidirectional

Product Preview NCS7030, NCS7031, NCV7030, NCV7031

The NCS7030 and NCS7031 are high voltage, current sense amplifiers. They are available with gain options of 14 V/V and 20 V/V, with a maximum $\pm 0.3\%$ gain error over the entire temperature range. Each part consists of a preamplifier and buffer with access to output and input via A1 and A2 pins for an intermediate filter network or modified gain. The current sense amplifiers offer excellent input common-mode rejection from -6 V to 80 V. They can perform unidirectional current measurements across a sense resistor in a variety of applications. Automotive qualified options are available under NCV prefix. All versions operate over the extended temperature range from -40°C to 150°C.

Features

- Bandwidth: 100 kHz
- Input Offset Voltage: ±300 µV Max Over Temp
- Offset Drift over Temperature: $\pm 3 \mu V/^{\circ}C$ max
- Gain Error: ±0.3 % Max Over Temp
- Quiescent Current: 1.5 mA Typ
- Supply Voltage: 3 V to 5.5 V
- Common-Mode Input Voltage Range: -6 V to 80 V Operating, -14 V to 85 V Survival
- CMRR: 85 dB Min
- PSRR: 75 dB Min
- Low-Pass Filter (1-pole or 2-pole)
- This is a Pb–Free Device

Typical Applications

- Telecom Equipment
- Power Supply Designs
- Diesel Injection Control
- Automotive
- Motor Control

This document contains information on a product under development. onsemi reserves the right to change or discontinue this product without notice.





Micro8 CASE 846A-02

SOIC-8 NB CASE 751-07



(Note: Microdot may be in either location)



ORDERING INFORMATION

See detailed ordering and shipping information on page 15 of this data sheet









PIN FUNCTION DESCRIPTION

NCS7031 (G = 20) Pinout	NCS7030 (G = 14) Pinout	Pin Name	Description
1	1	–IN	Inverting input – connect to sense resistor
2	2	GND	Device ground
3	3	A1	Pre-amp output connection
4	4	A2	Buffer amp input connection
5	5	OUT	Device output
6	7	V _S	Power supply connection
7	6	NC	No connect
8	8	+IN	Non-inverting input - connect to sense resistor

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage Range (Note 1)	V _S	–0.3 to 7	V
Input Common-Mode Range	V _{CM}	-14 to 85	V
Differential Input Voltage	V _{ID}	±V _S	V
Maximum Input Current	I _I	±10	mA
Maximum Output Current	Ι _Ο	±50	mA
Continuous Total Power Dissipation	PD	200	mW
Maximum Junction Temperature	T _{J(max)}	150	°C
Storage Temperature Range	T _{STG}	–65 to 150	℃
ESD Capability (Note 2) Human Body Model, Input pins Human Body Model, All other pins Charged Device Model	HBM HBM CDM	±7000 ±4000 ±1000	V
Latch-Up Current (Note 3)		±100	mA
Moisture Sensitivity Level	MSL	Level 1	-
Lead Temperature Soldering Reflow (SMD Styles Only), Pb-Free Versions (Note 4)	T _{SLD}	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per JS-001-2017 (AEC-Q100-002)

ESD Charged Device Model tested per JS-002-2014 (AEC-Q100-011)

3. Latch-up current maximum rating: ±100 mA per JEDEC standard JESD78E (AEC-Q100-004).

4. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS (Note 5)

Symbol	Parameter	Package	Value (Note 6)	Unit
θ_{JA}	Thermal Resistance, Junction-to-Air	Micro8	163	°C/W
		SOIC-8	128	°C/W
Ψ_{JT}	Thermal Characteristic, Junction-to-Case Top	Micro8	24.4	°C/W
		SOIC-8	28.5	°C/W
Ψ_{JB}	Thermal Characteristic, Junction-to- Board	Micro8	137.3	°C/W
		SOIC-8	103.5	°C/W

5. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

6. Values based on copper area of 645 mm² (or 1 in²) of 1 oz copper thickness and FR4 PCB substrate.

OPERATING RANGES (Note 7)

Rating	Symbol	Min	Мах	Unit
Supply Voltage	V _S	3	5.5	V
Common-Mode Input Voltage Range	nge V _{CM} –6		80	V
Ambient Temperature	T _A	-40	150 (Note 8)	°C

7. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

8. Operation up to T_A = 150°C is permitted, provided the total power dissipation is limited to prevent the junction temperature from exceeding the 150°C absolute maximum limit.

ELECTRICAL CHARACTERISTICS (At V _S = 5 V, T _A = +25°C, V _{CM} = 12 V, R _L \ge 10 k Ω , unless otherwise noted. Boldface limits
apply over the specified temperature range, guaranteed by characterization and/or design.)

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Symbol	Parameter	Condition	าร	Temp (°C)	Min	Тур	Max	Unit
GAIN								
G	Total Gain, Preamplifier and Buffer	G = 14 V//V G = 20 V/V		25	-	14 20	-	V/V
G _e	Gain Error			-40 to 125	-	-	±0.3	%
				-40 to 150	-	-	±0.5	
$\Delta G / \Delta T$	Gain Drift			-40 to 125	-	-	±20	ppm / °C
VOLTAGE C	OFFSET (Note 9)							
V _{OS}	Input Offset Voltage			25	-	±100	±300	μV
				-40 to 125	-	-	±300	
				-40 to 150			±400	
$\Delta V_{OS} / \Delta T$	Input Offset Voltage Drift over Temperature			-40 to 125	-	-	±3	μV / °C
INPUT		-						
V _{CM}	Common-Mode Input Voltage Range			-40 to 150	-6	-	80	V
CMRR	Common-Mode Rejection	$V_{CM} = -6 \text{ to } 80 \text{ V}$		-40 to 150	85	105	-	dB
	Hatio (Note 9)	f = 10 kHz V _{CM} = 12 V, 1 V _{PP}	G = 14 G = 20	-40 to 150	65 70	75 80		

PREAMPLIFIER

G _{PRE}	Gain	G = 14 V//V	25	-	7	-	V/V
		G = 20 V/V		-	10	-	
G _e	Gain Error		-40 to 125	-	-	±0.3	%
V _{OH}	Output Voltage Swing to V_S		-40 to 150	V _S – 0.05	V _S – 0.002	-	V
V _{OL}	Output Voltage Swing to GND		-40 to 150	-	1.5	25	mV
R _{PRE}	Output Resistance		25	98	100	102	kΩ
			-40 to 150	94	-	106	
I _{IB}	Input Bias Current		-40 to 125	-	200	500	μΑ

OUTPUT BUFFER

G _{OUT}	Gain	25	-	2	-	V/V
G _e	Gain Error	-40 to 125	-	-	±0.3	%
V _{OH}	Output Voltage Swing to V_{S}	-40 to 150	V _S - 0.05	V _S – 0.003	-	V
V _{OL}	Output Voltage Swing to GND	-40 to 150	-	0.5	25	mV
I _{IB}	Input Bias Current	-40 to 125	-	±5	±20	nA

DYNAMIC PERFORMANCE

BW	Bandwidth		25	-	100	-	kHz
SR	Slew Rate		25	-	1	1	V/μs
NOISE (Note	9)						
V _n	Voltage Noise, Peak-to-Peak	f = 0.1 Hz to 10 Hz	25	-	2	-	μV_{p-p}
e _N	Voltage Noise Density	f = 1 kHz	25	-	120	-	nV / √Hz

POWER SUPPLY

V _S	Operating Voltage Range	-40 to 150	3	-	5.5	V
I _{DD}	Quiescent Current	25	-	1.5	2.4	mA
		-40 to 125	-	-	2.7	
		-40 to 150	-	-	2.8	
PSRR	Power Supply Rejection Ratio	-40 to 150	75	90	-	dB

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 9. Referred to input





Figure 7. CMRR vs. Frequency

TYPICAL CHARACTERISTICS

At T_A = 25°C, V_S = 5 V, V_{CM} = 12 V, R_L = 10 k Ω , unless otherwise noted





At T_A = 25°C, V_S = 5 V, V_{CM} = 12 V, R_L = 10 k Ω , unless otherwise noted



TYPICAL CHARACTERISTICS

At T_A = 25°C, V_S = 5 V, V_{CM} = 12 V, R_L = 10 k\Omega, unless otherwise noted





Figure 21. PSRR vs. Frequency





APPLICATION INFORMATION

The NCS7030 and NCS7031 are current sense amplifiers featuring a wide common mode voltage up to 80 V independent of the supply voltage. The NCS703x current–sense amplifiers can be configured for both low–side and high–side current sensing.

Current Sensing Techniques

Low-side sensing appears to have the advantage of being straightforward, inexpensive, and can be implemented with

a simple op amp circuit. However, the NCS703x series of devices provides the full differential input necessary to get accurate shunt connections, while also providing a built–in gain network with precision difficult to obtain with external resistors. The NCS703x is shown in a low–side configuration in Figure 27 below.



Figure 27. Low-side Current Sensing

While at times the application requires low-side sensing, only high-side sensing can detect a short from the positive supply line to ground. Furthermore, high-side sensing avoids adding resistance to the ground path of the load being measured. The sections below focus primarily on high-side current sensing. Figure 28 shows the NCS703x configured for high-side current sensing.



Figure 28. High-side Current Sensing

Unidirectional Operation

In unidirectional current sensing, the measured load current always flows in the same direction. Common applications for unidirectional operation include power supplies and load current monitoring.

NCS703x is internally referenced to ground; therefore, it can only measure current flowing in one direction. The +IN pin of the NCS703x should be connected to the positive side of the sense resistor, while the –IN pin should be connected to the negative side of the sense resistor.

When no current is flowing though the R_{SHUNT} , the NCS703x output is expected to be within 50 mV of ground. When current is flowing through R_{SHUNT} , the output will swing positive, up to within 100 mV of the applied supply voltage, V_S .

$$V_{out} = (V_{+in} - V_{-in}) \times G$$

Power Supplies

The NCS703x can be connected to the same power supply that it is monitoring current from, or it can be connected to a separate power supply. If it is necessary to detect short circuit current on the load power supply, which may cause the load power supply to sag to near zero volts, a separate power supply must be used on the NCS703x. When using multiple supplies, there are no restrictions on power supply sequencing.

A1 and A2 Pins

A1 is the preamplifier output and the A2 is the buffer input. These pins can be used to make adjustments to the gain or to create a low-pass filter. The output of the preamplifier integrates a precision resistor of 100 k $\Omega \pm 2\%$, which can be utilized for either of these purposes.

The high impedances at the A1 and A2 pins make this connection particularly sensitive, and a careful layout is necessary if the high frequency response is required. Trace lengths should be kept at a minimum and test points should be avoided when possible at these pins. Even a small capacitance of 20 pF from the PCB can lower the -3dB signal bandwidth to 80 kHz. This filtering effect is useful for decreasing noise, and is further discussed in the upcoming "Filtering with A1 and A2" section.

Lowering the Gain with A1 and A2

The gain can be lowered by using the A1 and A2 pins. Connecting A1 to A2 and adding a resistor from this net to GND creates a resistor divider network in combination with the internal 100 k Ω resistor, as shown by Figure 29. For example, adding an external 100 k Ω resistor, reduces the voltage going into A2 by half, reducing the overall gain by half.



Figure 29. Lowering the Gain Using an External Resistor

The adjusted overall decreased gain, GADJ-, becomes a factor of the total nominal gain, G, and the external resistor, REXT.

$$G_{ADJ-} = \frac{G \times R_{EXT}}{R_{EXT} + 100 \text{ k}\Omega}$$

This equation can be rearranged to calculate the external resistor value for the desired gain value.

$$R_{EXT} = \frac{100 \text{ k}\Omega \times G_{ADJ-}}{G - G_{ADJ-}}$$

Increasing the Gain with A1 and A2

The gain can be increased by adding an external resistor in positive feedback as shown in Figure 30.

$$G_{ADJ+} = \frac{G \times R_{EXT}}{R_{EXT} - 100 \text{ k}\Omega}$$



Figure 30. Increasing the Gain Using an External Resistor in Positive Feedback

Filtering with A1 and A2

In some applications, the current being measured may be inherently noisy. A low-pass filter can be created by connecting A1 and A2 together and adding a capacitor from the net to GND as shown in Figure 31. This creates a simple RC filter with the internal 100 k Ω resistor. This single pole filter has a 20 dB/decade attenuation.



Figure 31. Implementing a Single-pole, Low-pass RC Filter

$$f_{FILT} = \frac{1}{2\pi(100 \text{ k}\Omega)C_{FILT}}$$

A two-pole filter with 40 dB/decade attenuation can be created with a Sallen-Key topology as shown in Figure 32.



Figure 32. Implementing a Two-pole, Low-pass Filter using the Sallen-Key Topology

Input Filtering

Some applications may require filtering at the input of the current sense amplifier. Figure 33 shows the recommended schematic for input filtering.



Figure 33. Input Filtering Compensates for Shunt Inductance on Shunts Less than 1 m Ω , as Well as High Frequency Noise in any Application

Input filtering is complicated by the fact that the added resistance of the filter resistors and the associated resistance mismatch between them can adversely affect gain, CMRR, and Vos. The effect on Vos is partly due to input bias currents as well. As a result, the value of the input resistors should be limited to 10 Ω or less.

As the shunt resistors decrease in value, shunt inductance can significantly affect frequency response. At values below 1 m Ω , the shunt inductance causes a zero in the transfer function that often results in corner frequencies in the low 100's of kHz. This inductance increases the amplitude of high frequency spike transient events on the current sensing line that can overload the front end of any shunt current sensing IC. This problem must be solved by filtering at the input of the amplifier. Note that all current sensing IC's are vulnerable to this problem, regardless of manufacturer claims. Filtering is required at the input of the device to resolve this problem, even if the spike frequencies are above the rated bandwidth of the device. Ideally, select the capacitor to exactly match the time constant of the shunt resistor and its inductance; alternatively, select the capacitor to provide a pole below that point. Make the input filter time constant equal to or larger than the shunt and its inductance time constant:

$$\frac{L_{SHUNT}}{R_{SHUNT}} \le 2R_{FILT}C_{FILT}$$

To determine the value of CFILT based on using 10 Ω resistors for each RFILT, the equation simplifies to:

$$C_{FILT} \geq \frac{L_{SHUNT}}{20R_{SHUNT}}$$

If the main purpose is to filter high frequency noise, the capacitor should be increased to a value that provides the desired filtering. As an example, a filtering frequency of 10 kHz would require an $0.8 \,\mu\text{F}$ capacitor.

$$f_{FILT} = \frac{1}{2\pi (2R_{FILT})C_{FILT}}$$

Common Mode Voltage Step Response

Large common mode voltage steps with fast slew rates can invoke transient voltage spikes on the output. Certain applications that operate with large common mode input voltage steps, including solenoid applications, require a thorough evaluation of the output response during such events.

There are a few methods to address this. One way to decrease the transient voltage spike is by decreasing the slew rate of the common mode voltage step. The measurement can also be filtered or averaged; this can be done by adding a low-pass filter using the A1 and A2 pins as described in the previous "Filtering with A1 and A2" section. Finally, there is the option of adding a time delay in the measurement after a common mode voltage step occurs.

The ac response to disturbances in the CMRR voltage is quantified to a certain degree in the CMRR vs. Frequency graph.

Advantages When Used For Low-Side Current Sensing

The NCS703x series offers many advantages for low-side current sensing. The true differential input is ideal for connection to either Kelvin Sensing shunts or conventional shunts. Additionally, the true differential input rejects the common-mode noise often present even in low-side current sensing. Providing all of this in a tiny package makes it very competitive when compared to discrete op amp solutions.

Selecting the Shunt Resistor

The desired accuracy of the current measurement determines the precision, shunt size, and the resistor value. The larger the resistor value, the more accurate the measurement possible, but a large resistor value also results in greater power loss.

For the most accurate measurements, use four terminal current sense resistors. It provides two terminals for the current path in the application circuit, and a second pair for the voltage detection path of the sense amplifier. This technique is also known as *Kelvin Sensing*. This insures that the voltage measured by the sense amplifier is the actual voltage across the resistor and does not include the small resistance of a combined connection. When using non–Kelvin shunts, closely follow manufacturers recommendations on how to lay out the sensing traces.

Shutting Down the NCS703x

While the NCS703x does not provide a shutdown pin, a simple MOSFET, power switch, or logic gate can be used to switch off the power to the NCS703x and eliminate the quiescent current. Note that the shunt input pins will always have a current flow via the input and feedback resistors. The input pins support the rated common mode voltage even when the NCS703x does not have power applied.

ORDERING INFORMATION

Gain	Device	Marking	Package	Shipping†
14	NCS7030D2G014R2G	7030014	SOIC-8 (Pb-Free)	2500 / Tape & Reel
	NCS7030DM2G014R2G	3014	Micro8 (Pb–Free)	4000 / Tape & Reel
20	NCS7031D1G020R2G	7031020	SOIC-8 (Pb-Free)	2500 / Tape & Reel
	NCS7031DM1G020R2G	3120	Micro8 (Pb–Free)	4000 / Tape & Reel

AUTOMOTIVE QUALIFIED

Gain	Device	Marking	Package	Shipping†
14	NCV7030D2G014R2G	7030014	SOIC-8 (Pb-Free)	2500 / Tape & Reel
	NCV7030DM2G014R2G	3014	Micro8 (Pb–Free)	4000 / Tape & Reel
20	NCV7031D1G020R2G	7031020	SOIC-8 (Pb-Free)	2500 / Tape & Reel
	NCV7031DM1G020R2G	3120	Micro8 (Pb–Free)	4000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN З. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. 8. CATHODE STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 COMMON ANODE/GND 5. 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT 2 OVI 0 UVLO З. 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE

6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK

7. VOULK 8. VIN

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SOURCE 1/DRAIN 2

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8. GATE 1

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